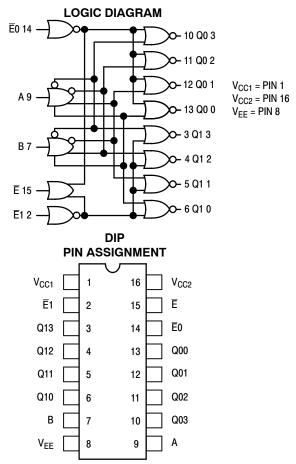
# **Dual Binary to 1-4-Decoder** (High)

# **Description**

The MC10H172 is a binary coded 2 line to dual 4 line decoder with selected outputs high. With either  $\overline{E}0$  or  $\overline{E}1$  low, the corresponding selected 4 outputs are low. The common enable  $\overline{E}$ , when high, forces all outputs low.

## **Features**

- Propagation Delay, 2 ns Typical
- Power Dissipation 325 mW Typical (same as MECL 10K<sup>TM</sup>)
- Improved Noise Margin 150 mV (over operating voltage and temperature range)
- Voltage Compensated
- MECL 10K Compatible
- Pb-Free Packages are Available\*



Pin assignment is for Dual-in-Line Package.
For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).



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# **MARKING DIAGRAMS\***

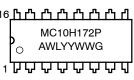






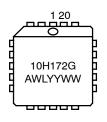


PDIP-16 P SUFFIX CASE 648





PLLC-20 FN SUFFIX CASE 775



A = Assembly Location WL, L = Wafer Lot

YY, Y = Year

WW, W = Work Week
G = Pb-Free Package

# **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

<sup>\*</sup>For additional marking information, refer to Application Note AND8002/D.

**Table 1. MAXIMUM RATINGS** 

Symbol	Characteristic	Rating	Unit
$V_{EE}$	Power Supply (V <sub>CC</sub> = 0)	-8 to 0	Vdc
VI	Input Voltage (V <sub>CC</sub> = 0)	0 to V <sub>EE</sub>	Vdc
l <sub>out</sub>	Output Current – Continuous – Surge	50 100	mA
T <sub>A</sub>	Operating Temperature Range	0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range - Plastic - Ceramic	-55 to +150 -55 to +165	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Table 2. ELECTRICAL CHARACTERISTICS ( $V_{EE}$  = -5.2 V  $\pm 5\%$ ) (Note 1)

		<b>0</b> °		<b>25</b> °		<b>75</b> °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
Ι <sub>Ε</sub>	Power Supply Current	-	85	-	77	-	85	mA
I <sub>inH</sub>	Input Current High	-	425	-	265	-	265	μΑ
I <sub>inL</sub>	Input Current Low	0.5	-	0.5	-	0.3	-	μΑ
V <sub>OH</sub>	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V <sub>OL</sub>	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V <sub>IH</sub>	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V <sub>IL</sub>	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

Each MECL 10H<sup>TM</sup> series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50 Ω resistor to -2.0 V.

**Table 3. AC PARAMETERS** 

		<b>0</b> °		<b>25</b> °		75°		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
t <sub>pd</sub>	Propagation Delay Data Select	0.5 0.5	2.0 2.6	0.5 0.5	2.1 2.7	0.5 0.5	2.2 2.8	ns
t <sub>r</sub>	Rise Time	0.5	1.7	0.5	1.8	0.5	1.9	ns
t <sub>f</sub>	Fall Time	0.5	1.7	0.5	1.8	0.5	1.9	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

**Table 4. TRUTH TABLE** 

	Enable Inp	ble Inputs Inputs				Outputs						
Ē	Ē1	E0	Α	В	Q1 0	Q1 1	Q1 2	Q1 3	Q0 0	Q0 1	Q0 2	Q0 3
L	Н	Н	L	L	Н	L	L	L	Н	L	L	L
L	Н	Н	L	Н	L	Н	L	L	L	Н	L	L
L	Н	Н	Н	L	L	L	Н	L	L	L	Н	L
L	Н	Н	Н	Н	L	L	L	Н	L	L	L	Н
L	L	Н	L	L	L	L	L	L	Н	L	L	L
L	Н	L	L	L	Н	L	L	L	L	L	L	L
Н	Х	Х	Х	X	L	L	L	L	L	L	L	L

X = Don't Care

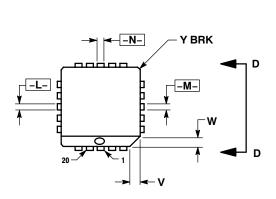
# **ORDERING INFORMATION**

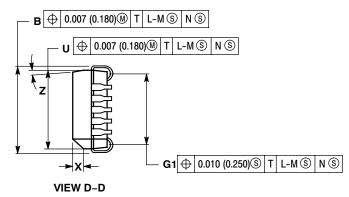
Device	Package	Shipping <sup>†</sup>
MC10H172FN	PLLC-20	46 Units / Rail
MC10H172FNG	PLLC-20 (Pb-Free)	46 Units / Rail
MC10H172FNR2	PLLC-20	500 / Tape & Reel
MC10H172FNR2G	PLLC-20 (Pb-Free)	500 / Tape & Reel
MC10H172L	CDIP-16	25 Unit / Rail
MC10H172P	PDIP-16	25 Unit / Rail
MC10H172PG	PDIP-16 (Pb-Free)	25 Unit / Rail

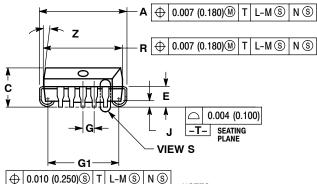
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

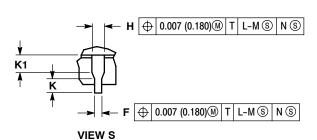
# PACKAGE DIMENSIONS

# **20 LEAD PLLC** CASE 775-02 **ISSUE E**









- NOTES:
  1. DIMENSIONS AND TOLERANCING PER ANSI Y14.5M, 1982.
- 1982.

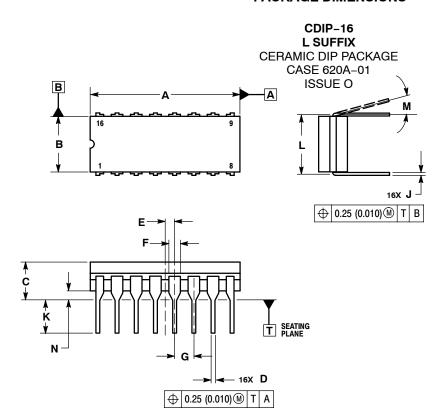
  DIMENSIONS IN INCHES.

  DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

- PARTING LINE.
  4. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM —T—, SEATING PLANE.
  5. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
  6. DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- PLASTIC BODY.
  7. DIMENSION H DOES NOT INCLUDE DAMBAR DIMIENSION HOUSEN OF INCLUDE DAMBAR
  PROTRUSION OR INTRUSION. THE DAMBAR
  PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION
  TO BE GREATER THAN 0.037 (0.940). THE DAMBAR
  INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO
  BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
С	0.165	0.180	4.20	4.57
Е	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
C	0.350	0.356	8.89	9.04
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020	-	0.50
Z	2°	10°	2°	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040		1.02	

## PACKAGE DIMENSIONS



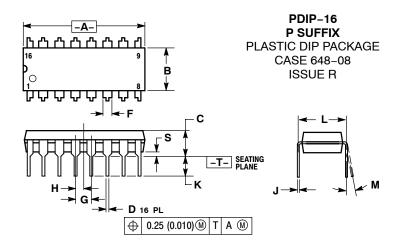
- ASTES.

  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

  2. CONTROLLING DIMENSION: INCH.

  3. DIMENSION L TO CENTER OF LEAD WHEN
- FORMED PARALLEL.
  DIMENSION F MAY NARROW TO 0.76 (0.030)
- WHERE THE LEAD ENTERS THE CERAMIC
- THIS DRAWING REPLACES OBSOLETE CASE OUTLINE 620-10.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62	BSC	
M	0°	15°	0°	15°	
N	0.020	0.040	0.51	1.01	



- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982.
  CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
- ROUNDED CORNERS OPTIONAL

	INC	HES	MILLIN	IETERS	
DIM	DIM MIN M		MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10°	0°	10 °	
S	0.020	0.040	0.51	1.01	

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